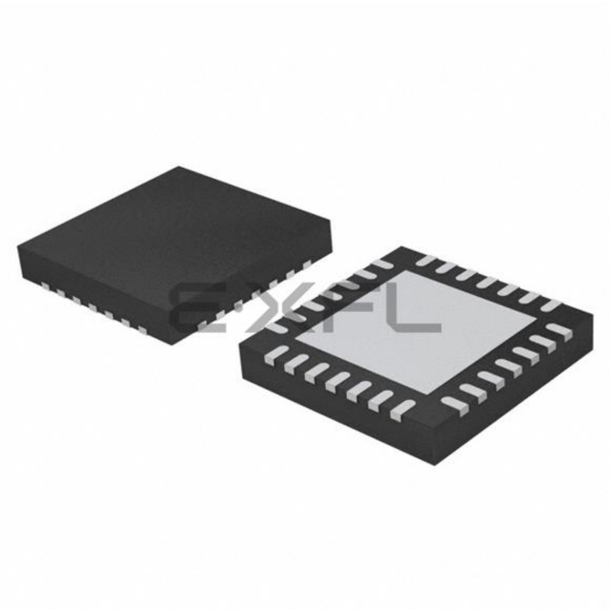

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	23
Program Memory Size	1KB (1K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0130qj020eg

CPU and Peripheral Overview

The eZ8 CPU, Zilog's latest 8-bit CPU, meets the continuing demand for faster and more code-efficient microcontrollers. The eZ8 CPU executes a superset of the original Z8 instruction set. The eZ8 CPU features include:

- Direct register-to-register architecture allows each register to function as an accumulator, improving execution time and decreasing the required program memory
- Software stack allows much greater depth in subroutine calls and interrupts than hardware stacks
- Compatible with existing Z8 CPU code
- Expanded internal register file allows access up to 4KB
- New instructions improve execution efficiency for code developed using high-level programming languages, including C
- Pipelined instruction fetch and execution
- New instructions for improved performance including BIT, BSWAP, BTJ, CPC, LDC, LDCI, LEA, MULT and SRL
- New instructions support 12-bit linear addressing of the register file
- Up to 10 MIPS operation
- C Compiler-friendly
- 2 to 9 clock cycles per instruction

For more information about the eZ8 CPU, refer to the eZ8 CPU Core User Manual (UM0128), which is available for download on www.zilog.com.

General Purpose Input/Output

The Z8 Encore! F0830 Series features up to 25 port pins (Ports A–D) for general-purpose input/output (GPIO). The number of GPIO pins available is a function of package. Each pin is individually programmable.

Flash Controller

The Flash Controller programs and erases the Flash memory. It also supports protection against accidental programming and erasure.

Table 4. Signal Descriptions (Continued)

Signal Mnemonic	I/O	Description
Oscillators		
X_{IN}	I	External crystal input. This is the input pin to the crystal oscillator. A crystal can be connected between it and the **XOUT** pin to form the oscillator. In addition, this pin is used with external RC networks or external clock drivers to provide the system clock.
X_{OUT}	O	External crystal output. This pin is the output of the crystal oscillator. A crystal can be connected between it and the **XIN** pin to form the oscillator.
Clock Input		
CLK_{IN}	I	Clock input signal. This pin may be used to input a TTL-level signal to be used as the system clock.
LED Drivers		
LED	O	Direct LED drive capability. All Port C pins have the capability to drive an LED without any other external components. These pins have programmable drive strengths set by the GPIO block.
On-Chip Debugger		
DBG	I/O	Debug. This signal is the control and data input and output to and from the On-Chip Debugger. **Caution:** The DBG pin is open-drain and requires an external pull-up resistor to ensure proper operation.
Reset		
$\overline{RESET}$	I/O	RESET. Generates a reset when asserted (driven Low). Also serves as a reset indicator; the Z8 Encore! forces this pin low when in reset. This pin is open-drain and features an enabled internal pull-up resistor.
Power Supply		
V_{DD}	I	Digital power supply.
AV_{DD}	I	Analog power supply.
V_{SS}	I	Digital ground.
AV_{SS}	I	Analog ground.

Note: The AV_{DD} and AV_{SS} signals are available only in the 28-pin packages with ADC. They are replaced by PB6 and PB7 on 28-pin packages without ADC.

Table 8. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No.
Interrupt Controller (cont'd)				
FCE	Shared interrupt select	IRQSS	00	66
FCF	Interrupt control	IRQCTL	00	67
GPIO Port A				
FD0	Port A address	PAADDR	00	39
FD1	Port A control	PACTL	00	41
FD2	Port A input data	PAIN	XX	41
FD3	Port A output data	PAOUT	00	41
GPIO Port B				
FD4	Port B address	PBADDR	00	39
FD5	Port B control	PBCTL	00	41
FD6	Port B input data	PBIN	XX	41
FD7	Port B output data	PBOUT	00	41
GPIO Port C				
FD8	Port C address	PCADDR	00	39
FD9	Port C control	PCCTL	00	41
FDA	Port C input data	PCIN	XX	41
FDB	Port C output data	PCOUT	00	41
GPIO Port D				
FDC	Port D address	PDADDR	00	39
FDD	Port D control	PDCTL	00	41
FDE	Reserved	—	XX	
FDF	Port D output data	PDOUT	00	41
FE0–FEF	Reserved	—	XX	
Watchdog Timer (WDT)				
FF0	Reset status	RSTSTAT	XX	95
	Watchdog Timer control	WDTCTL	XX	95
FF1	Watchdog Timer reload upper byte	WDTU	FF	96
FF2	Watchdog Timer reload high byte	WDTH	FF	96
FF3	Watchdog Timer reload low byte	WDTL	FF	97
FF4–FF5	Reserved	—	XX	

Note: XX = Undefined.

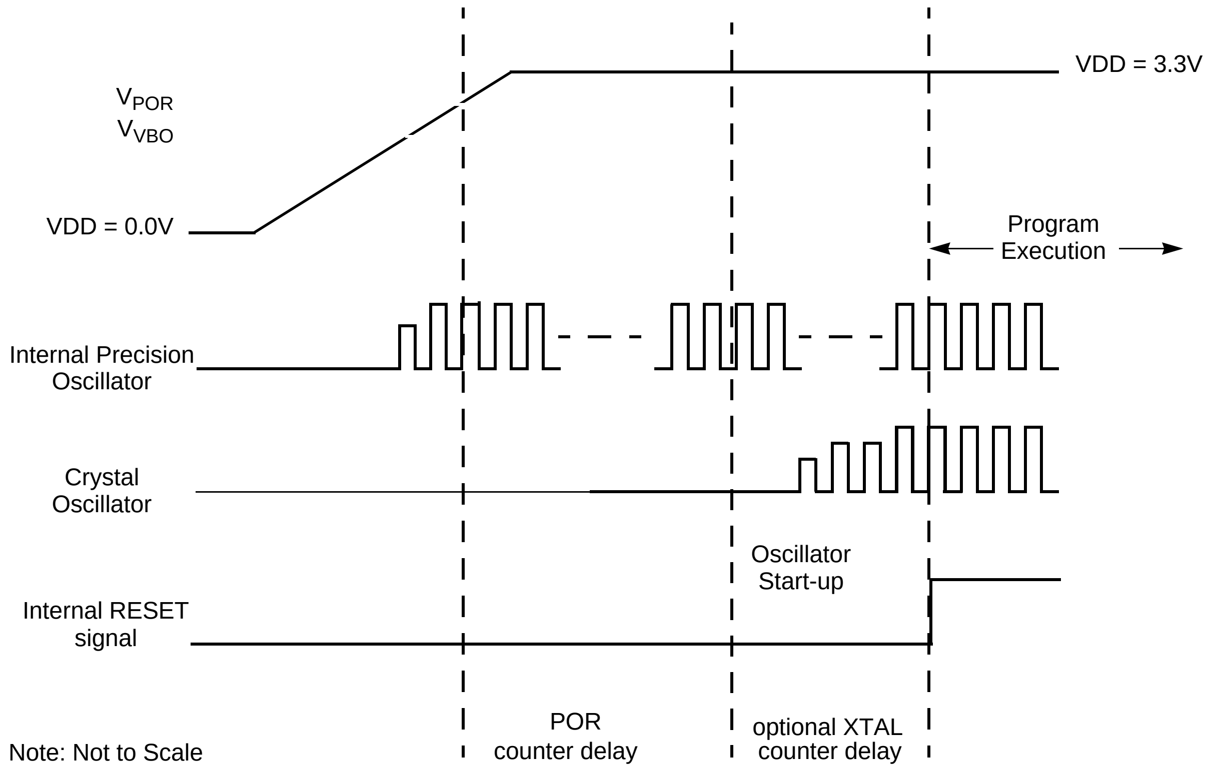

Figure 6. Power-On Reset Operation

Voltage Brown-Out Reset

The devices in the Z8 Encore! F0830 Series provide low Voltage Brown-Out (VBO) protection. The VBO circuit forces the device to the Reset state, when the supply voltage drops below the VBO threshold voltage (unsafe level). While the supply voltage remains below the Power-On Reset threshold voltage (V_{POR}), the VBO circuit holds the device in reset.

After the supply voltage exceeds the Power-On Reset threshold voltage, the device progresses through a full system reset sequence, as described in the POR section. Following Power-On Reset, the POR status bit in the Reset Status (RSTSTAT) Register is set to 1. Figure 7 displays the Voltage Brown-Out operation. See the Electrical Characteristics chapter on page 184 for the VBO and POR threshold voltages (V_{VBO} and V_{POR}).

The POR level is greater than the VBO level by the specified hysteresis value. This ensures that the device undergoes a POR after recovering from a VBO condition.

clock and reset signals, the required reset duration may be three or four clock periods. A reset pulse of three clock cycles in duration might trigger a reset and a reset pulse of four cycles in duration always triggers a reset.

While the $\overline{RESET}$ input pin is asserted low, the Z8 Encore! F0830 Series devices remain in the Reset state. If the $\overline{RESET}$ pin is held low beyond the system reset time-out, the device exits the Reset state on the system clock rising edge following $\overline{RESET}$ pin deassertion. Following a system reset initiated by the external $\overline{RESET}$ pin, the EXT status bit in the Reset Status (RSTSTAT) Register is set to 1.

External Reset Indicator

During system reset or when enabled by the GPIO logic, the $\overline{RESET}$ pin functions as an open-drain (active low) RESET mode indicator in addition to the input functionality. This reset output feature allows an Z8 Encore! F0830 Series device to reset other components to which it is connected, even if that reset is caused by internal sources such as POR, VBO or WDT events. See the Port A–D Control Registers section on page 41.

After an internal Reset event occurs, the internal circuitry begins driving the $\overline{RESET}$ pin low. The $\overline{RESET}$ pin is held low by the internal circuitry until the appropriate delay listed in Table 9 (see page 22) has elapsed.

On-Chip Debugger Initiated Reset

A Power-On Reset can be initiated using the On-Chip Debugger by setting the RST bit in the OCD Control Register. The OCD block is not reset, but the remainder of the chip goes through a normal system reset. The RST bit automatically clears during the system reset. Following the system reset, the POR bit in the Reset Status (RSTSTAT) Register is set.

Stop Mode Recovery

The device enters the STOP Mode when the STOP instruction is executed by the eZ8 CPU. See the Low-Power Modes chapter on page 30 for detailed STOP Mode information. During Stop Mode Recovery, the CPU is held in reset for about 66 IPO cycles if the crystal oscillator is disabled or about 5000 cycles if it is enabled.

Stop Mode Recovery does not affect the on-chip registers other than the Reset Status (RSTSTAT) Register and the Oscillator Control Register (OSCCTL). After any Stop Mode Recovery, the IPO is enabled and selected as the system clock. If another system clock source is required or IPO disabling is required, the Stop Mode Recovery code must reconfigure the oscillator control block such that the correct system clock source is enabled and selected.

HALT Mode

Executing the eZ8 CPU HALT instruction places the device into HALT Mode. In HALT Mode, the operating characteristics are:

- Primary oscillator is enabled and continues to operate
- System clock is enabled and continues to operate
- eZ8 CPU is stopped
- Program counter (PC) stops incrementing
- Watchdog Timer's internal RC oscillator continues to operate
- If enabled, the Watchdog Timer continues to operate
- All other on-chip peripherals continue to operate

The eZ8 CPU can be brought out of HALT Mode by any one of the following operations:

- Interrupt
- Watchdog Timer time-out (interrupt or reset)
- Power-On Reset
- Voltage Brown-Out reset
- External $\overline{\text{RESET}}$ pin assertion

To minimize current in HALT Mode, all GPIO pins that are configured as digital inputs must be driven to V_{DD} when pull-up register bit is enabled or to one of power rail (V_{DD} or GND) when pull-up register bit is disabled.

Peripheral Level Power Control

In addition to the STOP and HALT modes, it is possible to disable each peripheral on each of the Z8 Encore! F0830 Series devices. Disabling a given peripheral minimizes its power consumption.

Power Control Register Definitions

Power Control Register 0

Each bit of the following registers disables a peripheral block, either by gating its system clock input or by removing power from the block.

GPIO Interrupts

Many of the GPIO port pins can be used as interrupt sources. Some port pins can be configured to generate an interrupt request on either the rising edge or falling edge of the input pin signal. Other port pin interrupt sources, generate an interrupt when any edge occurs (both rising and falling). See the Interrupt Controller chapter on page 53 for more information about interrupts using the GPIO pins.

GPIO Control Register Definitions

Four registers for each port provide access to GPIO control, input data and output data; Table 17 lists these port registers. Use the Port A–D Address and Control registers together to provide access to subregisters for port configuration and control.

Table 17. GPIO Port Registers and Subregisters

Port Register Mnemonic	Port Register Name
P*x*ADDR	Port A–D Address Register (selects subregisters)
P*x*CTL	Port A–D Control Register (provides access to subregisters)
P*x*IN	Port A–D Input Data Register
P*x*OUT	Port A–D Output Data Register
Port Subregister Mnemonic	**Port Register Name**
P*x*DD	Data Direction
P*x*AF	Alternate Function
P*x*OC	Output Control (open-drain)
P*x*HDE	High Drive Enable
P*x*SMRE	Stop Mode Recovery Source Enable
P*x*PUE	Pull-Up Enable
PxAFS1	Alternate Function Set 1
PxAFS2	Alternate Function Set 2

5. Enable the timer interrupt, if appropriate and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt is generated for both input capture and Reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting the TICONFIG field of the TxCTL1 Register.
6. Configure the associated GPIO port pin for the timer input alternate function.
7. Write to the Timer Control Register to enable the timer and initiate counting.

In CAPTURE Mode, the elapsed time between the timer start and the capture event can be calculated using the following equation:

$$\text{Capture Elapsed Time (s)} = \frac{(\text{Capture Value} - \text{Start Value}) \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

CAPTURE RESTART Mode

In CAPTURE RESTART Mode, the current timer count value is recorded when the acceptable external timer input transition occurs. The capture count value is written to the timer PWM High and Low Byte registers. The timer input is the system clock. The TPOL bit in the Timer Control Register determines whether the capture occurs on a rising edge or a falling edge of the timer input signal. When the capture event occurs, an interrupt is generated and the count value in the Timer High and Low Byte registers is reset to `0001H` and counting resumes. The INPCAP bit in the TxCTL1 Register is set to indicate that the timer interrupt has been caused by an input capture event.

If no capture event occurs, the timer counts up to 16-bit compare value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to `0001H` and counting resumes. The INPCAP bit in the TxCTL1 Register is cleared to indicate that the timer interrupt has not been caused by an input capture event.

Observe the following steps for configuring a timer for CAPTURE RESTART Mode and for initiating the count:

1. Write to the Timer Control Register to:
   - Disable the timer
   - Configure the timer for CAPTURE RESTART Mode; setting the mode also involves writing to TMODEHI bit in the TxCTL1 Register
   - Set the prescale value
   - Set the capture edge (rising or falling) for the timer input

2. Write to the Timer High and Low Byte registers to set the starting count value (typically `0001H`).

Flash information area is mapped into program memory and overlays the 128 bytes in the address range `FE00H` to `FE7FH`. When the information area access is enabled, all reads from these program memory addresses return the information area data rather than the program memory data. Access to the Flash information area is read-only.

The trim bits are handled differently than the other Zilog Flash option bits. The trim bits are the hybrid of the user option bits and the standard Zilog option bits. These trim bits must be user-accessible for reading at all times using external registers regardless of the state of bit 7 in the Flash Page Select Register. Writes to the trim space change the value of the Option Bit Holding Register but do not affect the Flash bits, which remain as read-only.

Table 70. Z8F083 Flash Memory Area Map

Program Memory Address (Hex)	Function
FE00–FE3F	Zilog option bits
FE40–FE53	Part number 20-character ASCII alphanumeric code Left justified and filled with FH
FE54–FE5F	Reserved
FE60–FE7F	Reserved

Operation

The Flash Controller programs and erases Flash memory. The Flash Controller provides the proper Flash controls and timing for byte programming, page erase and mass erase of Flash memory.

The Flash Controller contains several protection mechanisms to prevent accidental programming or erasure. These mechanism operate on the page, sector and full-memory levels.

The flowchart in Figure 19 display basic Flash Controller operation. The following subsections provide details about the various operations (Lock, Unlock, Byte Programming, Page Protect, Page Unprotect, Page Select Page Erase and Mass Erase) displayed in Figure 19.

Flash Operation Timing Using the Flash Frequency Registers

Before performing either a Program or Erase operation on Flash memory, the user must first configure the Flash Frequency High and Low Byte registers. The Flash frequency registers allow programming and erasing of the Flash with system clock frequencies ranging from 10kHz to 20MHz.

The Flash Frequency High and Low Byte registers combine to form a 16-bit value, `FFREQ`, to control the timing for Flash Program and Erase operations. The 16-bit binary Flash frequency value must contain the system clock frequency (in kHz). This value is calculated using the following equation:

$$\text{FFREQ[15:0]} = \frac{\text{System Clock Frequency (Hz)}}{1000}$$

> **! Caution:** Flash programming and erasure are not supported for system clock frequencies below 10kHz or above 20MHz. The Flash Frequency High and Low Byte registers must be loaded with the correct value to ensure operation of the Z8 Encore! F0830 Series devices.

Flash Code Protection Against External Access

The user code contained within Flash memory can be protected against external access by using the On-Chip Debugger. Programming the FRP Flash option bit prevents reading of the user code using the On-Chip Debugger. For more information, see the Flash Option Bits chapter on page 124 and the On-Chip Debugger chapter on page 139.

Flash Code Protection Against Accidental Program and Erasure

The Z8 Encore! F0830 Series provides several levels of protection against accidental program and erasure of the Flash memory contents. This protection is provided by a combination of the Flash option bits, the register locking mechanism, the page select redundancy and the sector level protection control of the Flash Controller.

Flash Code Protection Using the Flash Option Bits

The FHSWP and FWP Flash option bits combine to provide three levels of Flash program memory protection, as listed in Table 71. See the Flash Option Bits chapter on page 124 for more information.

bits can only be set to 1. Thus, sectors can be protected, but not unprotected, via register write operations. Writing a value other than `5EH` to the Flash Control Register deselects the Flash Sector Protect Register and reenables access to the Page Select Register. Observe the following procedure to setup the Flash Sector Protect Register from user code:

1. Write `00H` to the Flash Control Register to reset the Flash Controller.
2. Write `5EH` to the Flash Control Register to select the Flash Sector Protect Register.
3. Read and/or write the Flash Sector Protect Register which is now at Register File address `FF9H`.
4. Write `00H` to the Flash Control Register to return the Flash Controller to its reset state.

The Sector Protect Register is initialized to 0 on reset, putting each sector into an unprotected state. When a bit in the Sector Protect Register is written to 1, the corresponding sector can no longer be written or erased. After setting a bit in the Sector Protect Register, the bit cannot be cleared by the user.

Byte Programming

Flash memory is enabled for byte programming after unlocking the Flash Controller and successfully enabling either mass erase or page erase. When the Flash Controller is unlocked and mass erase is successfully enabled, all of the program memory locations are available for byte programming. In contrast, when the Flash Controller is unlocked and page erase is successfully enabled, only the locations of the selected page are available for byte programming. An erased Flash byte contains all 1's (`FFH`). The programming operation can only be used to change bits from 1 to 0. To change a Flash bit (or multiple bits) from 0 to 1 requires execution of either the page erase or mass erase commands.

Byte programming can be accomplished using the On-Chip Debugger's write memory command or eZ8 CPU execution of the LDC or LDCI instructions. Refer to the eZ8 CPU Core User Manual (UM0128), which is available for download on www.zilog.com, for the description of the `LDC` and `LDCI` instructions. While the Flash Controller programs the Flash memory, the eZ8 CPU idles, but the system clock and on-chip peripherals continue to operate. To exit programming mode and lock the Flash, write any value to the Flash Control Register, except the mass erase or page erase commands.

! **Caution:** The byte at each address within Flash memory cannot be programmed (any bits written to 0) more than twice before an erase cycle occurs.

Operation

The following section describes the operation of the On-Chip Debugging function.

OCD Interface

The On-Chip Debugger uses the DBG pin for communication with an external host. This one-pin interface is a bidirectional open-drain interface that transmits and receives data. Data transmission is half-duplex, which means that transmission and data retrieval cannot occur simultaneously. The serial data on the DBG pin is sent using the standard asynchronous data format defined in RS-232.This pin creates an interface between the Z8 Encore! F0830 Series products and the serial port of a host PC using minimal external hardware. Two different methods for connecting the DBG pin to an RS-232 interface are displayed in Figures 21 and 22. The recommended method is the buffered implementation depicted in Figure 22. The DBG pin must always be connected to V_{DD} through an external pull-up resistor.

! **Caution:** For proper operation of the On-Chip Debugger, all power pins (V_{DD} and AV_{DD}) must be supplied with power and all ground pins (V_{SS} and AV_{SS}) must be properly grounded. The DBG pin is open-drain and must always be connected to V_{DD} through an external pull-up resistor to ensure proper operation.

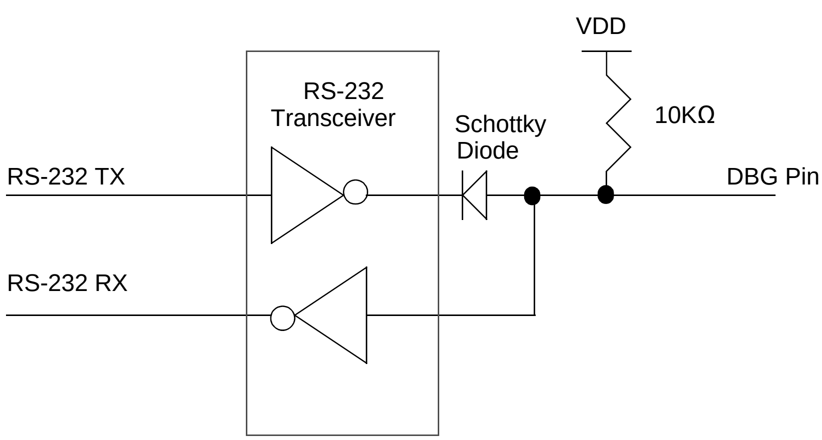

Figure 21. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface, #1 of 2

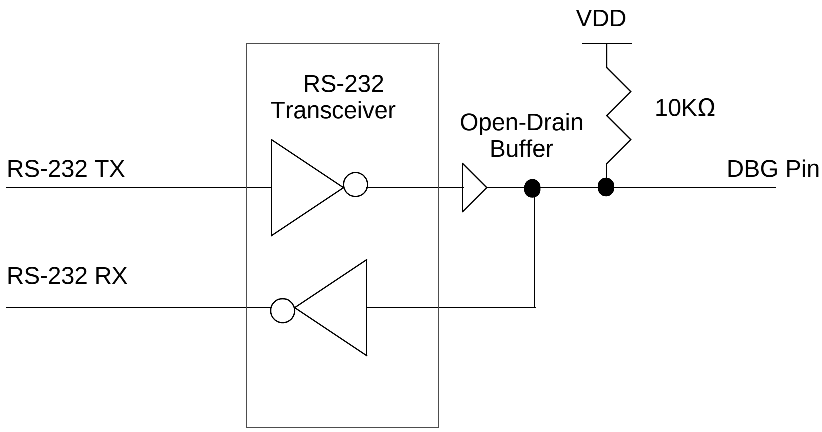

Figure 22. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface, #2 of 2

DEBUG Mode

The operating characteristics of the devices in DEBUG Mode are:

- The eZ8 CPU fetch unit stops, idling the eZ8 CPU, unless directed by the OCD to execute specific instructions
- The system clock operates, unless the device is in STOP Mode
- All enabled on-chip peripherals operate, unless the device is in STOP Mode
- Automatically exits HALT Mode
- Constantly refreshes the Watchdog Timer, if enabled

Entering DEBUG Mode

- The device enters DEBUG Mode after the eZ8 CPU executes a Breakpoint (BRK) instruction
- If the DBG pin is held low during the most recent clock cycle of system reset, the device enters DEBUG Mode on exiting system reset

Exiting DEBUG Mode

The device exits DEBUG Mode following any of these operations:

- Clearing the DBGMODE bit in the OCD Control Register to 0
- Power-On Reset
- Voltage Brown-Out reset

Table 95. On-Chip Debugger Command Summary (Continued)

Debug Command	Command Byte	Enabled when not in DEBUG Mode?	Disabled by Flash Read Protect Option Bit
Read Program Memory CRC	0EH	–	–
Reserved	0FH	–	–
Step Instruction	10H	–	Disabled
Stuff Instruction	11H	–	Disabled
Execute Instruction	12H	–	Disabled
Reserved	13H–FFH	–	–

In the following bulleted list of OCD commands, data and commands sent from the host to the OCD are identified by `DBG` ← `Command/Data`. Data sent from the OCD back to the host is identified by `DBG Data`.

Read OCD Revision (00H). The read OCD revision command determines the version of the On-Chip Debugger. If OCD commands are added, removed or changed this revision number changes.

```
DBG ← 00H
DBG → OCDRev[15:8] (Major revision number)
DBG → OCDRev[7:0] (Minor revision number)
```

Read OCD Status Register (02H). The read OCD Status Register command reads the OCDSTAT register.

```
DBG ← 02H
DBG → OCDSTAT[7:0]
```

Read Runtime Counter (03H). The runtime counter counts system clock cycles in between breakpoints. The 16-bit runtime counter counts from `0000H` and stops at the maximum count of `FFFFH`. The runtime counter is overwritten during the write memory, read memory, write register, read register, read memory CRC, step instruction, stuff instruction and execute instruction commands.

```
DBG ← 03H
DBG → RuntimeCounter[15:8]
DBG → RuntimeCounter[7:0]
```

Write OCD Control Register (04H). The write OCD Control Register command writes the data that follows to the OCDCTL register. When the Flash read protect option bit is enabled, the DBGMODE bit (`OCDCTL`[7]) can only be set to 1, it cannot be cleared to 0. To return the device to normal operating mode, the device must be reset.

```
DBG ← 04H
DBG ← OCDCTL[7:0]
```

Table 114. Op Code Map Abbreviations

Abbreviation	Description	Abbreviation	Description
b	Bit position	IRR	Indirect Register Pair
cc	Condition code	p	Polarity (0 or 1)
X	8-bit signed index or displacement	r	4-bit Working Register
DA	Destination address	R	8-bit register
ER	Extended Addressing Register	r1, R1, Ir1, Irr1, IR1, rr1, RR1, IRR1, ER1	Destination address
IM	Immediate data value	r2, R2, Ir2, Irr2, IR2, rr2, RR2, IRR2, ER2	Source address
Ir	Indirect Working Register	RA	Relative
IR	Indirect Register	rr	Working Register Pair
Irr	Indirect Working Register Pair	RR	Register Pair

Table 128. Z8 Encore! XP F0830 Series Ordering Matrix

Part Number	Flash	RAM	NVDS	ADC Channels	Description
Z8F0831HH020EG	8KB	256	Yes	0	SSOP 20-pin
Z8F0831PH020EG	8KB	256	Yes	0	PDIP 20-pin
Z8F0831QH020EG	8KB	256	Yes	0	QFN 20-pin
Z8F0830SJ020EG	8KB	256	Yes	8	SOIC 28-pin
Z8F0830HJ020EG	8KB	256	Yes	8	SSOP 28-pin
Z8F0830PJ020EG	8KB	256	Yes	8	PDIP 28-pin
Z8F0830QJ020EG	8KB	256	Yes	8	QFN 28-pin
Z8F0831SJ020EG	8KB	256	Yes	0	SOIC 28-pin
Z8F0831HJ020EG	8KB	256	Yes	0	SSOP 28-pin
Z8F0831PJ020EG	8KB	256	Yes	0	PDIP 28-pin
Z8F0831QJ020EG	8KB	256	Yes	0	QFN 28-pin
Z8 Encore! F0830 with 4KB Flash					
Standard Temperature: 0°C to 70°C					
Z8F0430SH020SG	4KB	256	Yes	7	SOIC 20-pin
Z8F0430HH020SG	4KB	256	Yes	7	SSOP 20-pin
Z8F0430PH020SG	4KB	256	Yes	7	PDIP 20-pin
Z8F0430QH020SG	4KB	256	Yes	7	QFN 20-pin
Z8F0431SH020SG	4KB	256	Yes	0	SOIC 20-pin
Z8F0431HH020SG	4KB	256	Yes	0	SSOP 20-pin
Z8F0431PH020SG	4KB	256	Yes	0	PDIP 20-pin
Z8F0431QH020SG	4KB	256	Yes	0	QFN 20-pin
Z8F0430SJ020SG	4KB	256	Yes	8	SOIC 28-pin
Z8F0430HJ020SG	4KB	256	Yes	8	SSOP 28-pin
Z8F0430PJ020SG	4KB	256	Yes	8	PDIP 28-pin
Z8F0430QJ020SG	4KB	256	Yes	8	QFN 28-pin
Z8F0431SJ020SG	4KB	256	Yes	0	SOIC 28-pin
Z8F0431HJ020SG	4KB	256	Yes	0	SSOP 28-pin
Z8F0431PJ020SG	4KB	256	Yes	0	PDIP 28-pin
Z8F0431QJ020SG	4KB	256	Yes	0	QFN 28-pin
Extended Temperature: –40°C to 105°C					
Z8F0430SH020EG	4KB	256	Yes	7	SOIC 20-pin
Z8F0430HH020EG	4KB	256	Yes	7	SSOP 20-pin
Z8F0430PH020EG	4KB	256	Yes	7	PDIP 20-pin

Hex Addresses: F87–F8F

This address range is reserved.

Comparator 0

For more information about the Comparator Register, see the Comparator Control Register Definitions section on page 107.

Hex Address: F90

Table 156. Comparator Control Register (CMP0)

Bit	7	6	5	4	3	2	1	0
Field	Reserved	INNSEL	REFLVL				Reserved	
RESET	0	0	0	1	0	1	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F90H							

Hex Addresses: F91–FBF

This address range is reserved.

Interrupt Controller

For more information about the Interrupt Control registers, see the Interrupt Control Register Definitions section on page 57.

Hex Address: FC0

Table 157. Interrupt Request 0 Register (IRQ0)

Bit	7	6	5	4	3	2	1	0
Field	Reserved	T1I	T0I	Reserved	Reserved	Reserved	Reserved	ADCI
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC0H							

Hex Address: FFB

Table 196. Flash Frequency Low Byte Register (FFREQL)

Bit	7	6	5	4	3	2	1	0
Field	FFREQL							
RESET	0							
R/W	R/W							
Address	FFBH							

M

N

O